# DATA SHEET 74LV00 Quad 2-input NAND gate

INTEGRATED CIRCUITS

Product specification Supersedes data of 1998 Apr 13 IC24 Data Handbook 1998 Apr 20







# 74LV00

#### **FEATURES**

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V<sub>CC</sub> = 2.7 V and V<sub>CC</sub> = 3.6 V
- Typical V<sub>OLP</sub> (output ground bounce) < 0.8 V at V<sub>CC</sub> = 3.3 V,  $T_{amb} = 25^{\circ}C$
- Typical V<sub>OHV</sub> (output V<sub>OH</sub> undershoot) > 2 V at V<sub>CC</sub> = 3.3 V,  $T_{amb} = 25^{\circ}C$
- Output capability: standard
- I<sub>CC</sub> category: SSI

#### QUICK REFERENCE DATA

#### GND = 0 V; $T_{amb} = 25^{\circ}C$ ; $t_r = t_f \le 2.5$ ns SYMBOL PARAMETER CONDITIONS TYPICAL UNIT Propagation delay $C_{L} = 15 \text{ pF};$ t<sub>PHL</sub>/t<sub>PLH</sub> 7 ns nA, nB to nY $V_{CC} = 3.3 V$ CI 3.5 Input capacitance pF Power dissipation capacitance per gate See Notes 1 and 2 22 pF CPD

DESCRIPTION

function compatible with 74HC/HCT00.

The 74LV00 provides the 2-input NAND function.

The 74LV00 is a low-voltage Si-gate CMOS device that is pin and

NOTES:

1.  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W)  $\begin{array}{l} \mathsf{P}_{D} = \mathsf{C}_{PD} \times \mathsf{V}_{CC}^2 \times \mathsf{f}_i + \mathop{\sum}\limits_{} (\mathsf{C}_L \times \mathsf{V}_{CC}^2 \times \mathsf{f}_o) \text{ where:} \\ \mathsf{f}_i = \mathsf{input} \text{ frequency in MHz; } \mathsf{C}_L = \mathsf{output} \text{ load capacitance in pF;} \\ \mathsf{f}_o = \mathsf{output} \text{ frequency in MHz; } \mathsf{V}_{CC} = \mathsf{supply voltage in V;} \\ \mathop{\sum}\limits_{} (\mathsf{C}_L \times \mathsf{V}_{CC}^2 \times \mathsf{f}_o) = \mathsf{sum of the outputs.} \end{array}$ 

2. The condition is  $V_1 = GND$  to  $V_{CC}$ .

#### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	–40°C to +125°C	74LV00 N	74LV00 N	SOT27-1
14-Pin Plastic SO	–40°C to +125°C	74LV00 D	74LV00 D	SOT108-1
14-Pin Plastic SSOP Type II	–40°C to +125°C	74LV00 DB	74LV00 DB	SOT337-1
14-Pin Plastic TSSOP Type I	–40°C to +125°C	74LV00 PW	74LV00PW DH	SOT402-1

#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	FUNCTION
1, 4, 9, 12	1A – 4A	Data inputs
2, 5, 10, 13	1B – 4B	Data inputs
3, 6, 8, 11	1Y – 4Y	Data outputs
7	GND	Ground (0 V)
14	V <sub>CC</sub>	Positive supply voltage

#### **FUNCTION TABLE**

INP	OUTPUTS	
nA	nB	nY
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

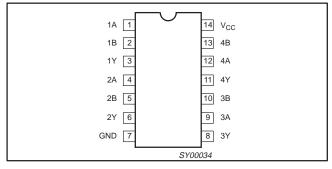
NOTES:

H = HIGH voltage level

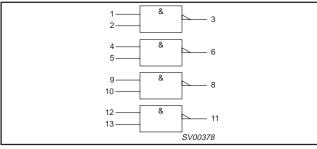
L = LOW voltage level

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## **PIN CONFIGURATION**

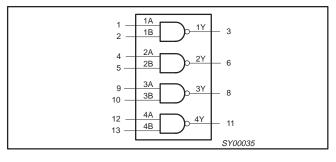


## LOGIC SYMBOL (IEEE/IEC)

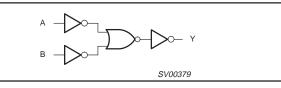


**RECOMMENDED OPERATING CONDITIONS** 

## LOGIC SYMBOL



## LOGIC DIAGRAM (ONE GATE)



#### SYMBOL PARAMETER CONDITIONS MIN TYP. MAX UNIT See Note 1 5.5 V<sub>CC</sub> DC supply voltage 1.0 3.3 V VI Input voltage 0 \_ V<sub>CC</sub> V V<sub>CC</sub> V Output voltage 0 $V_{O}$ \_ See DC and AC -40 +85 Operating ambient temperature range in free air °C Tamb characteristics -40 +125 $V_{\rm CC} = 1.0V$ to 2.0V 500 \_ \_ $V_{CC} = 2.0V \text{ to } 2.0V$ $V_{CC} = 2.7V \text{ to } 3.6V$ $V_{CC} = 3.6V \text{ to } 5.5V$ 200 — \_ Input rise and fall times ns/V t<sub>r</sub>, t<sub>f</sub> \_ 100 \_ \_ 50

NOTE:

1. The LV is guaranteed to function down to  $V_{CC}$  = 1.0V (input levels GND or  $V_{CC}$ ); DC characteristics are guaranteed from  $V_{CC}$  = 1.2V to  $V_{CC}$  = 5.5V.

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#### ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
±Ι <sub>ΙΚ</sub>	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5 V$	20	mA
±Ι <sub>ΟΚ</sub>	DC output diode current	$V_{\rm O}$ < -0.5 or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5V	50	mA
±IO	DC output source or sink current – standard outputs	$-0.5V < V_{O} < V_{CC} + 0.5V$	25	mA
±I <sub>GND</sub> , ±I <sub>CC</sub>	DC V <sub>CC</sub> or GND current for types with – standard outputs		50	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
P <sub>TOT</sub>	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

#### NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

#### DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

					LIMITS				
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	o +125°C	Ι υνιτ	
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	1	
		$V_{CC} = 1.2V$	0.9			0.9			
VIH	HIGH level Input	$V_{CC} = 2.0V$	1.4			1.4			
۷IH	voltage	V <sub>CC</sub> = 2.7 to 3.6V	2.0		1	2.0		V	
		V <sub>CC</sub> = 4.5 to 5.5V	0.7*V <sub>CC</sub>			0.7*V <sub>CC</sub>		1	
		V <sub>CC</sub> = 1.2V			0.3		0.3		
M	LOW level Input	$V_{CC} = 2.0V$		1	0.6		0.6		
V <sub>IL</sub>	voltage	V <sub>CC</sub> = 2.7 to 3.6V			0.8		0.8	1 `	
		V <sub>CC</sub> = 4.5 to 5.5			0.3*V <sub>CC</sub>		0.3*V <sub>CC</sub>	1	
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$		1.2					
		$V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	1.8	2.0		1.8		1	
	HIGH level output voltage; all outputs	$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.5	2.7		2.5		V	
	vonago, an outputo	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.8	3.0		2.8			
		$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	4.3	4.5		4.3		1	
V <sub>OH</sub>	HIGH level output voltage;	$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 6mA$	2.40	2.82		2.20		V	
V OH	STANDARD outputs	$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 12mA$	3.60	4.20		3.50		] `	
		$V_{CC}$ = 1.2V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $I_O$ = 100 $\mu$ A		0					
		$V_{CC}$ = 2.0V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $I_O$ = 100 $\mu$ A		0	0.2		0.2		
V <sub>OL</sub>	LOW level output voltage; all outputs	$V_{CC}$ = 2.7V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $I_O$ = 100 $\mu$ A		0	0.2		0.2	V	
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2		
		$V_{CC}$ = 4.5V; $V_I$ = $V_{IH}$ or $V_{IL;} I_O$ = 100 $\mu$ A		0	0.2		0.2		
LOW level output voltage;	voltage;	$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 6mA$		0.25	0.40		0.50	V	
V <sub>OL</sub>	STANDARD outputs	$V_{CC}$ = 4.5V; $V_{I}$ = $V_{IH}$ or $V_{IL}$ ; $I_{O}$ = 12mA		0.35	0.55		0.65	] `	

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#### DC ELECTRICAL CHARACTERISTICS (Continued)

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	+125°C	UNIT
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	
I	Input leakage current	$V_{CC}$ = 5.5V; $V_{I}$ = $V_{CC}$ or GND			1.0		1.0	μΑ
Icc	Quiescent supply current; SSI	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		40	μΑ
ΔI <sub>CC</sub>	Additional quiescent supply current	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$			500		850	μΑ

#### NOTE:

1. All typical values are measured at  $T_{amb} = 25^{\circ}C$ .

#### **AC CHARACTERISTICS**

GND = 0V;  $t_r = t_f \le 2.5$ ns; C<sub>L</sub> = 50pF; R<sub>L</sub> = 1K $\Omega$ 

		CONDITION															
SYMBOL	PARAMETER	WAVEFORM	CONDITION		40 to +85 °	С	-40 to -	⊦125 °C	UNIT								
			V <sub>CC</sub> (V)	MIN	TYP <sup>1</sup>	MAX	MIN	MAX									
	Propagation delay <sup>t</sup> PHL/PLH nA, nB to nY	Propagation delay			1.2		45										
				-							[	2.0		15	26		31
t <sub>PHL/PLH</sub>			Figures 1, 2	2.7		11	18		23	ns							
			3.0 to 3.6		9 <sup>2</sup>	15		18									
			4.5 to 5.5		6.5 <sup>3</sup>	11		14									

#### NOTES:

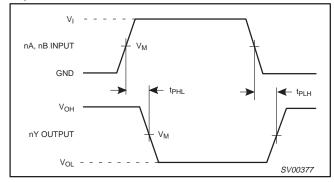
1. Unless otherwise stated, all typical values are measured at  $T_{amb} = 25^{\circ}C$ .

2. Typical values are measured at V<sub>CC</sub> = 3.3 V.

3. Typical values are measured at  $V_{CC} = 5.0$  V.

### AC WAVEFORMS

 $V_M$  = 1.5 V at  $V_{CC}$   $\geq$  2.7 V and  $\leq$  3.6 V;  $V_M$  = 0.5  $\times$   $V_{CC}$  at  $V_{CC}$  < 2.7 V and  $\geq$  4.5 V;  $V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.





#### **TEST CIRCUIT**

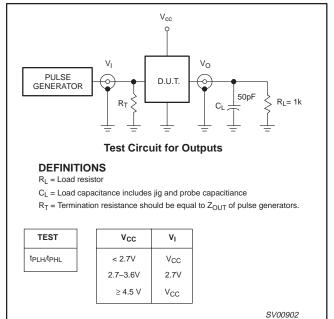
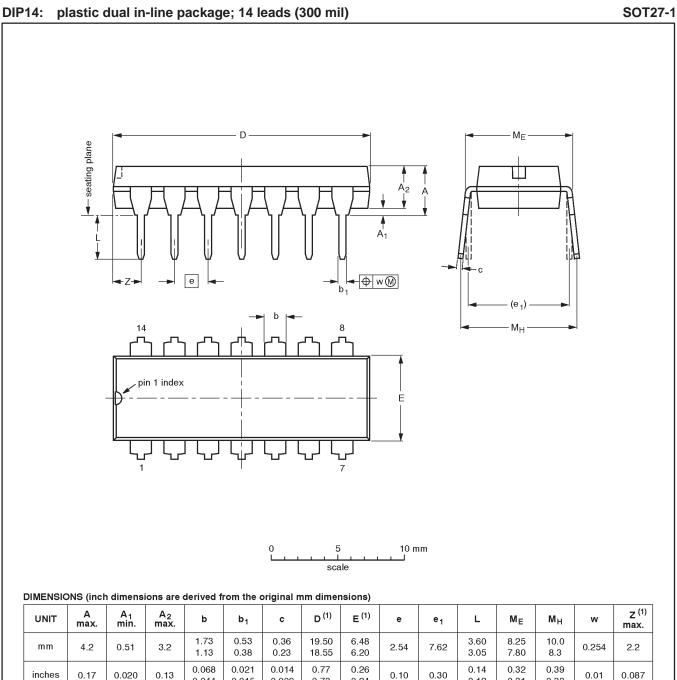


Figure 2. Load circuitry for switching times.



Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

0.044

0.015

0.009

OUTLINE	REFERENCES							
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE		
SOT27-1	050G04	MO-001AA				<del>-92-11-17</del> 95-03-11		

0.24

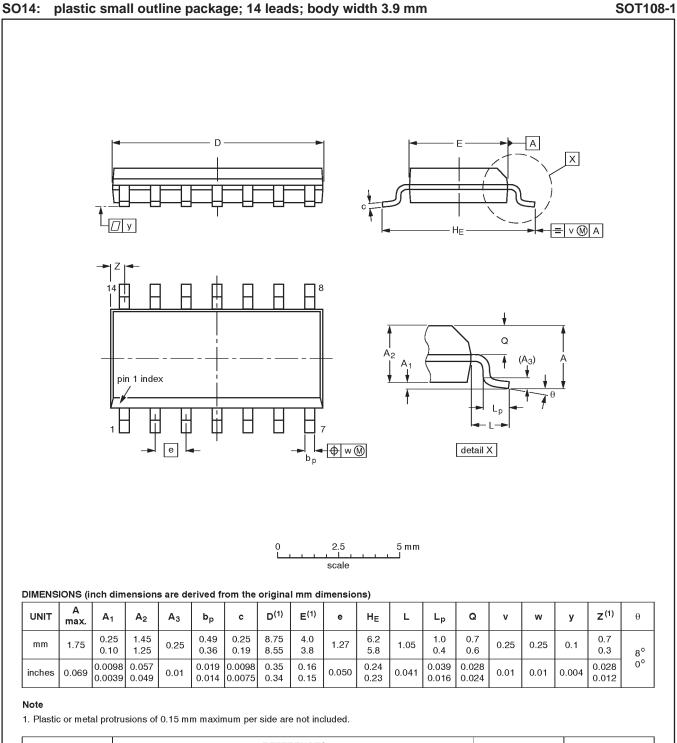
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0.31

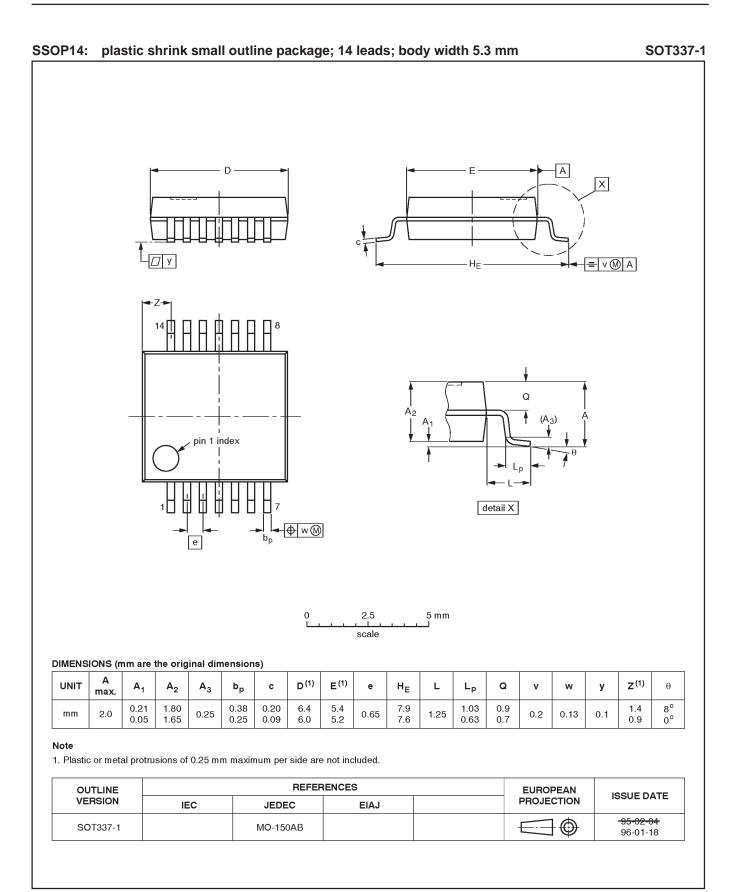
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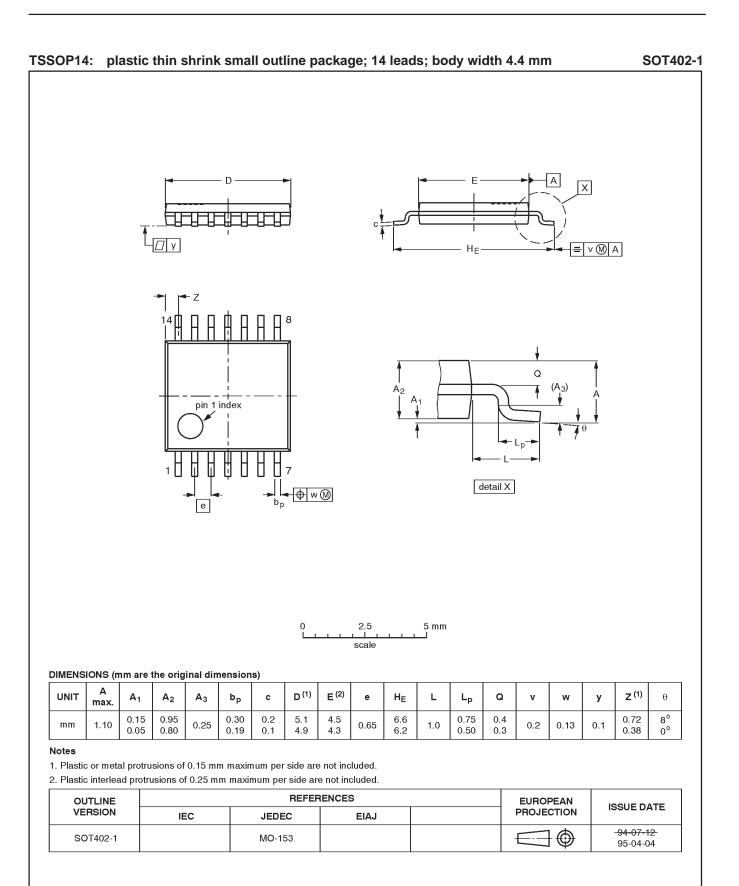
0.73

Product specification



OUTLINE	REFERENCES						
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT108-1	076E06S	MS-012AB				<del>91-08-13</del> 95-01-23	





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DEFINITIONS					
Data Sheet Identification	Product Status	Definition			
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.			
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